

-20V P-Channel Enhancement Mode MOSFET

Description

The AP2307AI uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

 $V_{DS} = -20V I_{D} = -7A$

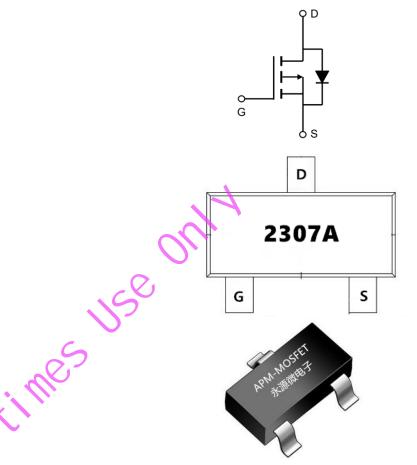
 $R_{DS(ON)} < 25m\Omega @ V_{GS} = -4.5V$ (Type:20m Ω)

Application

Quick charge

electronic cigarette

Uninterruptible power supply



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP2307AI	SOT23L	2307A	3000

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	-20 V	
VGS	Gate-Source Voltage	±12	V
Id@T₄=25°C	Continuous Drain Current, V _{GS} @ -4.5V ¹	-7	A
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ -4.5V ¹	-4.8	A
Ідм	Pulsed Drain Current ²	-23.8	A
P _D @T _A =25°C	Total Power Dissipation ³	2	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Reja	Thermal Resistance Junction-ambient ¹	62.5	°C/W
Rejc	Thermal Resistance Junction-Case ¹	80	°C/W

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Electrical Characteristics (TJ=25°C, unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D = -250µA	-20	-22	-	V
IDSS	Zero Gate Voltage Drain Current	V _{DS} = -20V, V _{GS} =0V,	-	-	-1	μA
IGSS	Gate to Body Leakage Current	V_{DS} =0V, V_{GS} = ±12V	-	-	±100	nA
VGS(th)	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D = -250µA	-0.5	-0.7	-1.2	V
RDS(on)	Static Drain-Source on-Resistance note2	V _{GS} = -4.5V, I _D = -6A	-	20	25	
		V _{GS} = -2.5V, I _D = -5A	-	28	35	mΩ
Ciss	Input Capacitance		-	2000	-	pF
Coss	Output Capacitance	V _{DS} = -10V, V _{GS} =0V, f=1.0MHz		242	-	pF
Crss	Reverse Transfer Capacitance	\sim		231	-	pF
Qg	Total Gate Charge	V _{DS} = -10V, I _D = -3A, V _{GS} = -4.5V	-	15.3	-	nC
Q_{gs}	Gate-Source Charge		-	2.2	-	nC
Q _{gd}	Gate-Drain("Miller") Charge		-	4.4	-	nC
td(on)	Turn-on Delay Time		-	10	-	ns
tr	Turn-on Rise Time	V _{DD} = -10V, I _D = -7A, V _{GS} = -4.5V,	-	31	-	ns
td(off)	Turn-off Delay Time	R _{GEN} =2.5Ω	-	28	-	ns
t _f	Turn-off Fall Time		-	8	-	ns
IS	Maximum Continuous Drain to Source Diode Forward Current		-	-	-7	А
ISM	Maximum Pulsed Drain to Source Diode Forward Current		-	-	-28	А
VSD	Drain to Source Diode Forward Voltage	V _{GS} =0V, I _S = -7A	-	-0.8	-1.2	V

Note :

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1. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.

2、The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

 $3\,{\scriptstyle \sim}\,$ The power dissipation is limited by 150 ${\rm ^{\circ}C}$ junction temperature

4. The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.

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Typical Characteristics

<u>AP2307AI</u>

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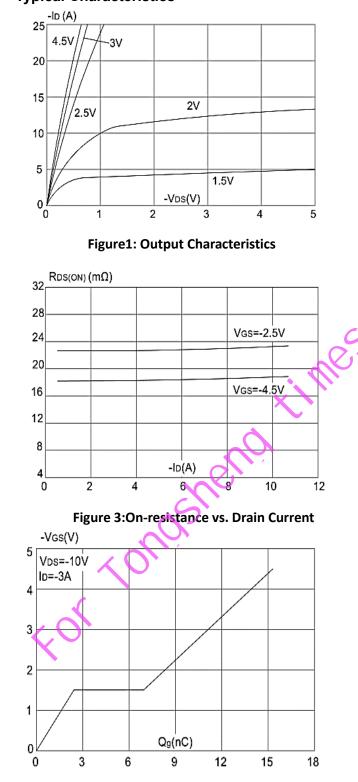


Figure 5: Gate Charge Characteristics

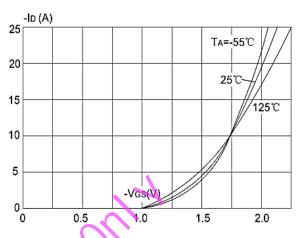


Figure 2: Typical Transfer Characteristics

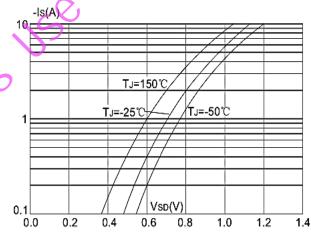


Figure 4: Body Diode Characteristics

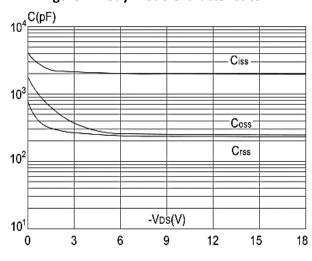
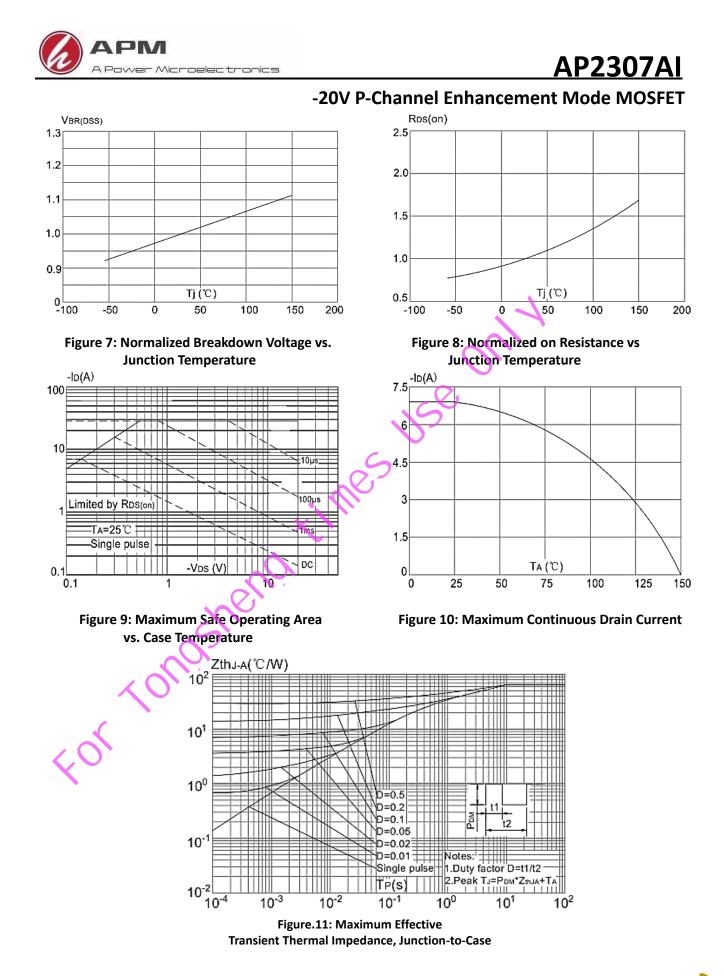


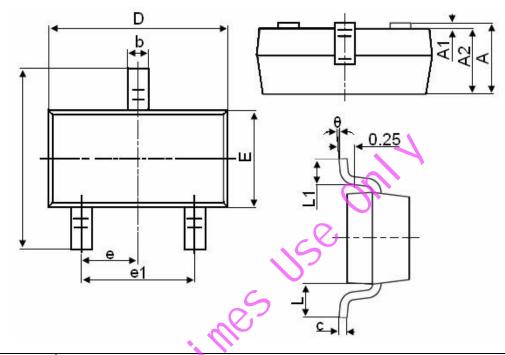
Figure 6: Capacitance Characteristics





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Package Mechanical Data-SOT23-XC-Single



Symbol	Dimensions in Millimeters	
Symbol	MIN.	MAX.
А	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
Æ	1.200	1.400
CE1	2.250	2.550
е	0.950TYP	
e1	1.800	2.000
L	0.550REF	
L1	0.300	0.500
θ	0°	8°



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Edition	Date	Change
Rve1.0	2020/12/20	Initial release

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